



Intel[®] Programmable Acceleration Card (PAC) with Intel[®] Arria[®] 10 GX FPGA Data Sheet



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1. Introduction

Figure 1. Intel® Programmable Acceleration Card with Intel® Arria® 10 GX FPGA



This datasheet for the Intel® PAC with Intel Arria® 10 GX FPGA shows electrical, mechanical, compliance, and other key specifications. This datasheet assists data center operators and system integrators to properly deploy this PAC into their servers. It also documents the FPGA power envelope, connectivity speeds to memory, and network connectivity, so that accelerator function unit (AFU) developers can properly design and test their IP.

The PAC is supported by the Intel Acceleration Stack for Intel Xeon® CPU with FPGAs. The Intel Acceleration Stack provides a common developer interface to both application and acceleration function developers and includes drivers, Application Programming Interfaces (APIs) and an FPGA Interface Manager (FIM).

Along with acceleration libraries and development tools, the Acceleration Stack saves development time and enables code re-use across multiple Intel FPGA form-factor products, allowing the developer to focus on the unique value-addition of their solution. Developers can use the [Accelerator Functional Unit \(AFU\) User Guide](#) to get started.



Intel validates each Intel Programmable Acceleration Card with Intel Arria 10 GX FPGA to support large scale deployments requiring FPGA acceleration. This platform is targeted for market-specific acceleration in applications such as:

- Big Data Analytics
- Artificial Intelligence
- Video Transcoding
- Cyber Security
- Genomics
- High-Performance Computing
- Finance

This document supports Acceleration Stack versions 1.1 and 1.2.

Related Information

[Intel Acceleration Stack Quick Start Guide for Intel Programmable Acceleration Card with Arria 10 GX FPGA](#)

2. Overview

This chapter provides an overview of the programmable acceleration card and describes the board architecture and its components.

2.1. Views of the Intel PAC with Intel Arria 10 GX FPGA

Figure 2. Intel PAC with Intel Arria 10 GX FPGA Internals

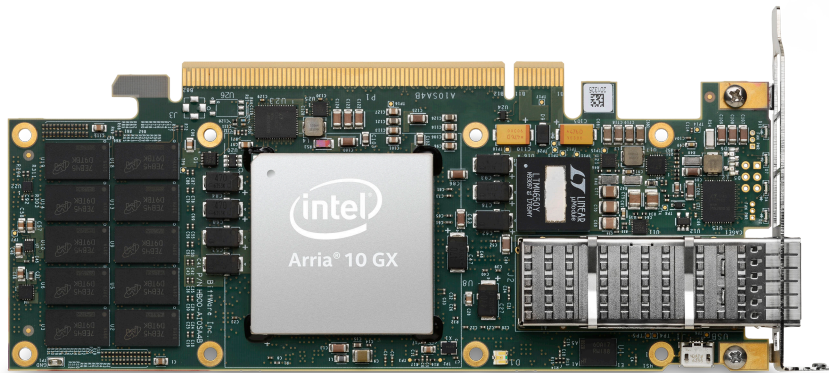
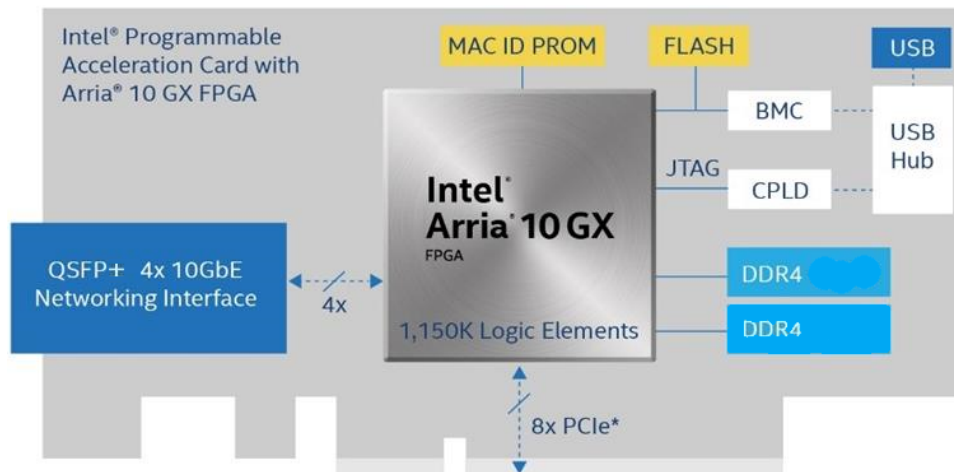


Figure 3. Intel PAC with Intel Arria 10 GX FPGA Conceptual View



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2.2. Overview of Product Features

2.2.1. Intel Arria 10 GX FPGA

The Intel Arria 10 FPGAs feature industry-leading programmable logic built on 20 nm process technology that integrate a rich feature set of embedded peripherals, embedded high-speed transceivers, hard memory controllers and IP protocol controllers. Variable-precision digital signal processing (DSP) blocks integrated with hardened floating point (IEEE 754-compliant) enable the Intel Arria 10 FPGAs to deliver floating point performance of up to 1.5 TFLOPS. Arria 10 FPGAs have a comprehensive set of power-saving features. Combined, these features allow developers to build versatile set of acceleration solutions.

When developing the accelerator function for the Intel PAC, select the 10AX115N2F40E2LG device.

Related Information

- [Intel FPGA Devices](#)
Detailed information about features of the Intel Arria 10 GX FPGA family
- [Intel Arria 10 Device Datasheet](#)
This datasheet describes the electrical characteristics, switching characteristics, configuration specifications, and I/O timing for Intel Arria 10 devices.
- [Intel Arria 10 Device Overview](#)
This device overview provides information about known device issues affecting Intel Arria 10 GX/GT devices. It also offers design recommendations you should follow when using Intel Arria 10 GX/GT devices.

2.2.2. On-Board Memory

- 8 GB Double Data Rate 4 (DDR-4) memory
 - 2133 Mbps
 - Two 4 GB DDR-4 memory banks, part number MT40A512M16JY-083E:B
 - Width: 64 data bits

Note: Refer to the *Accelerator Functional Unit (AFU) Developer's Guide* for access within the FIM to this memory link.
- One 1 GB (128 MB) Flash – for use with the FIM

Related Information

[Accelerator Functional Unit \(AFU\) Developer's Guide](#)

2.2.3. Interfaces and Dimensions

- PCI Express (PCIe) x8 Gen3 electrical, x16 mechanical for stability
Note: The Intel PAC with Intel Arria 10 GX FPGA does not support PCIe Gen4.
- USB 2.0 interface for debugging. Also available as an alternative to PCIe for programming FPGA and flash.
- 1x Quad Small Form Factor Pluggable+ (QSFP+) with 4x 10GbE or 40GbE support.
- Conforms to 1 Rack Unit.



- ½ Length, full height card with air duct installed (default)
- ½ Length, ½ height card with air duct removed and low profile bracket installed
- Standard bracket available with air duct addition available.

Note: One rack unit is 44.5 mm (1.75 inches) high. One rack unit is commonly designated as "1U".

2.2.4. Software

- Acceleration Stack for Intel Xeon CPU with FPGAs
- FIM Installed
Note: Certain development sample boards may be supplied without the FIM installed.
- Board Management Controller firmware

Related Information

[Intel FPGA Acceleration Hub](#)

Information about the Intel Acceleration Stack.

2.2.5. Power

- 66W TDP
 - The TDP is based on the max current, per the PCIe specification, of 5.5A on the 12V rail.
 - As the developers or solution provider, you must ensure that the AFU does not exceed this limit or the limit provided by the qualified server vendor. Functionality and reliability of the server is not supported for AFUs that exceed the specification.
- Up to 45 W FPGA power consumption
- The PAC source power is from the 12V rail of the PCIe* edge connector. The PAC does not draw power from the 3.3V rail.

2.2.6. CPLD

The CPLD is an Intel FPGA Download Cable. JTAG is used for debug and instances where the FIM image is corrupted or needs to be updated.

2.2.7. QSFP+

The Intel PAC with Intel Arria 10 GX FPGA has a QSFP+ cage on the front panel which supports 40GbE or four 10GbE.

The table below details the Intel-supported connectors. For volume deployment, you must use Intel-validated QSFP+ cables.

Successful functioning of 40GbE and 10GbE requires appropriate physical medium attachment (PMA) settings. Run the provided PMA settings script as detailed in the *10Gbps Ethernet Accelerator Functional Unit (AFU) Design Example User Guide* or *40Gbps Ethernet Accelerator Functional Unit (AFU) Design Example User Guide*.



Table 1. QSFP+ Support for the Intel Programmable Acceleration Card with Intel Arria 10 GX FPGA

| | Model Number |
|---|--------------|
| Intel Ethernet QSFP+ 1-meter direct attach cable (DAC) twinaxial cables | XLDACBL1 |
| Intel Ethernet QSFP+ 3-meter direct attach cable (DAC) twinaxial cables | XLDACBL3 |
| Intel Ethernet QSFP+ short reach (SR) optic module | E40QSFP SR |
| Intel Ethernet QSFP+ 1-meter Passive Breakout Cable | X4DACBL1 |
| Intel Ethernet QSFP+ 3-meter Passive Breakout Cable | X4DACBL3 |

Switches

Intel has validated the following switches:

Table 2. Intel-Validated Switches

| Ethernet AFU | Switch Brand | Switch Model Number |
|------------------|-------------------|-----------------------|
| 40 Gbps Ethernet | Dell* | Z9100-ON |
| | Extreme Networks* | x870-32C |
| | Mellanox* | SN2700 |
| 10 Gbps Ethernet | Cisco* | Nexus N9K-C93180YC-EX |
| | Lenovo* | 8272 |
| | Dell | 8024F |

QSFP+ SerDes

The QSFP+ interface has four Serializer/Deserializer (SerDes) lanes connected directly to the FPGA.

Related Information

- [Running 10GbE PAC-to-PAC Test between two connected PACs in the 10Gbps Ethernet Accelerator Functional Unit \(AFU\) Design Example User Guide](#)
- [Running 40GbE PAC-to-PAC Test between two connected PACs in the 40Gbps Ethernet Accelerator Functional Unit \(AFU\) Design Example User Guide](#)

2.2.8. Control and Support

The following features are available on this acceleration card for configuration, control and support:

- USB
- PCIe
- Board Management Controller (BMC)

2.2.8.1. USB Overview

This acceleration card has a USB 2.0 port (J1) for debug and configuration in select cases. The USB interface is used for the following:



- Read/write Intel Arria 10 FPGA configuration in Flash
- Read manufacturing data via USB
- Monitor on-board temperature and power
- Update the board's BMC firmware
- JTAG access to the Intel Arria 10 FPGA through the board's embedded Intel FPGA Download Cable

Note: The specification of the inbound hub is USB 2.0 but it auto-negotiates from a USB 3.0 host PC.

2.2.8.2. PCIe Overview

This acceleration card has a PCIe interface for configuration in select cases. When Intel Acceleration Stack for Intel Xeon CPU with FPGAs version 1.2 and the latest BMC firmware are installed, the PCIe interface can be used for the following:

- Read/write Intel Arria 10 FPGA configuration in Flash
- Read manufacturing data via USB
- Monitor on-board temperature and power
- Update the board's BMC firmware

2.2.8.3. Board Management Controller Overview

The Board Management Controller (BMC) is responsible for controlling, monitoring and giving low-level access to board features. The BMC microcontroller interfaces with on-board sensors, the FPGA and the flash, and it controls power and resets. The microcontroller communicates over PCIe I²C using:

- Platform Level Data Model (PLDM) for Platform Monitoring and Control version 1.1.1
- The Open Programmable Acceleration Engine (OPAE) FPGA tool

The firmware that runs on the BMC microcontroller is field upgradeable over PCIe or USB.

You can use a BittWorks ToolKit to access utilities and libraries for communicating to devices on the platform at a higher, more abstract level.

You can flash the BMC firmware and read sensor data with the OPAE commands `fpgaflash` and `fpgainfo`.

For more details, refer to the *Board Management Controller* section.

Related Information

[Board Management Controller](#) on page 18

3. System Compatibility

This section describes the platforms and Linux™ distribution targeted for the acceleration card validation.

Platforms

Refer to the [Qualified Servers and Ordering Information](#) page for a list of the latest qualified servers.

Operating System Validation

Table 3. Operating System Validation

| Operating Systems (OS) | OS Family |
|------------------------|-----------|
| RHEL™ 7.4 | RHEL |
| CentOS 7.4 | CentOS |
| Ubuntu 16.04 | Ubuntu |

Note: The above mentioned Operating Systems are Linux Kernel 3.10.

Adapters must have the following PCIe ID and power/thermal budget.

- Note:**
- VID - Vendor ID
 - SVID - Sub Vendor ID
 - DID - Device ID
 - SDID - Sub Device ID

Table 4. PCIe ID and Power/Thermal Budget

| PAC | PCIe VID | PCIe DID | PCIe SVID | PCIe SDID |
|---------------------------------------|----------|----------|-----------|-----------|
| Intel PAC with Intel Arria 10 GX FPGA | 0x8086 | 0x09C4 | 0x8086 | 0x0000 |

Table 5. Ordering Code vs. Intel Acceleration Stack Version Compatibility

| Ordering Code | Intel Acceleration Stack Version | | |
|--------------------|----------------------------------|-----|-----|
| | 1.0 | 1.1 | 1.2 |
| DK-ACB-10AX1151AES | Yes | Yes | Yes |
| DK-ACB-10AX1152AES | Not validated | Yes | Yes |

Note: If you purchased a board from a qualified OEM, please contact the OEM to confirm which version(s) of the Acceleration Stack it supports.

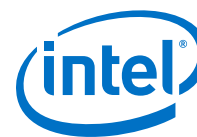


Table 6. Validated BMC and Intel Acceleration Stack Versions

| Intel Acceleration Stack Version | BMC Firmware Version |
|----------------------------------|----------------------|
| 1.0 | 26815 |
| 1.1 Alpha | 26819 |
| 1.1 Beta and Production | 26822 |
| 1.2 Early Access | 26889 |
| 1.2 | 26889 |

PACs ordered under the following codes are development samples and should not be used for volume deployment.

Table 7. Development Samples

| OPN | MM# |
|--------------------|--------|
| DK-ACB-10AX1151AES | 980016 |
| DK-ACB-10AX1152AES | 980017 |

4. Mechanical Information

Dimensions of the Intel PAC with Intel Arria 10 GX FPGA

- Standard height, half length PCIe card
- Low profile option available
- Card Weight with air duct: 255 g
- Maximum component height: 14.47 mm
- PCIe x16 mechanical

Figure 4. Acceleration Card - Standard Profile Bracket with Airduct



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Figure 5. Air Duct Assembly

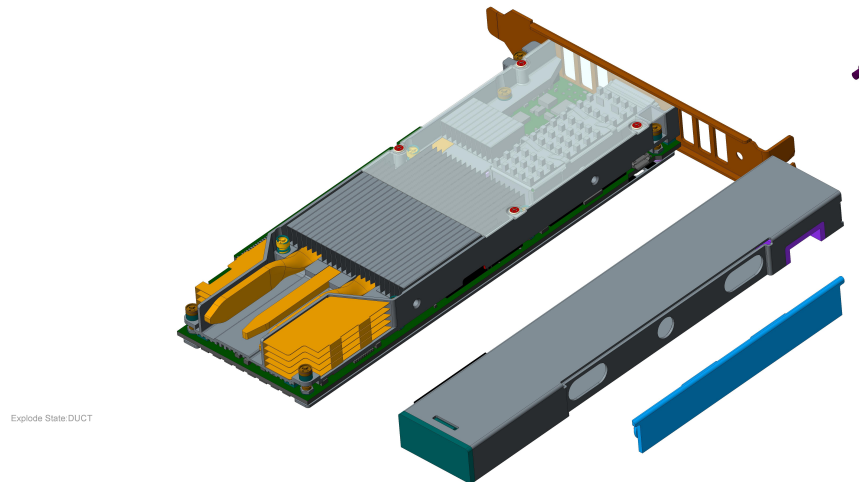


Figure 6. Acceleration Card - Low Profile Bracket

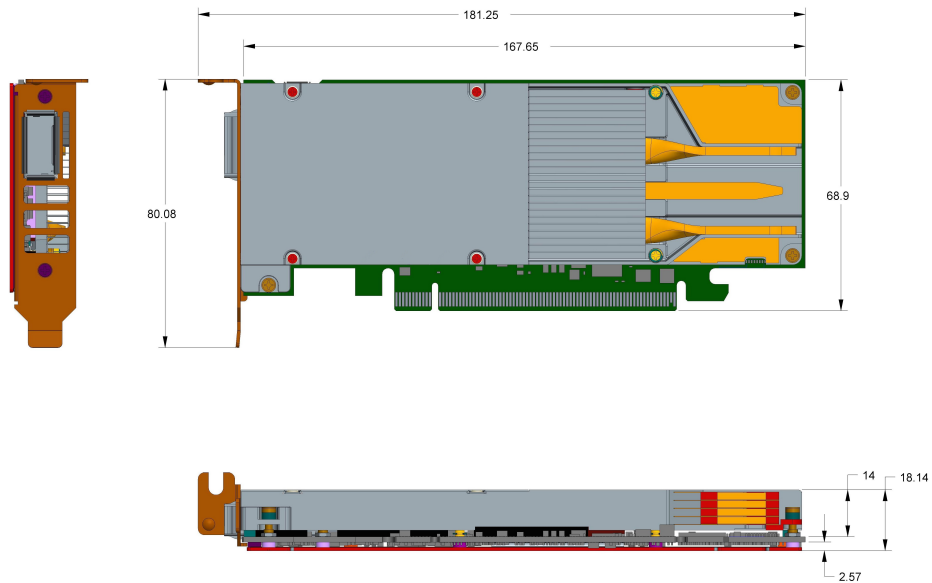
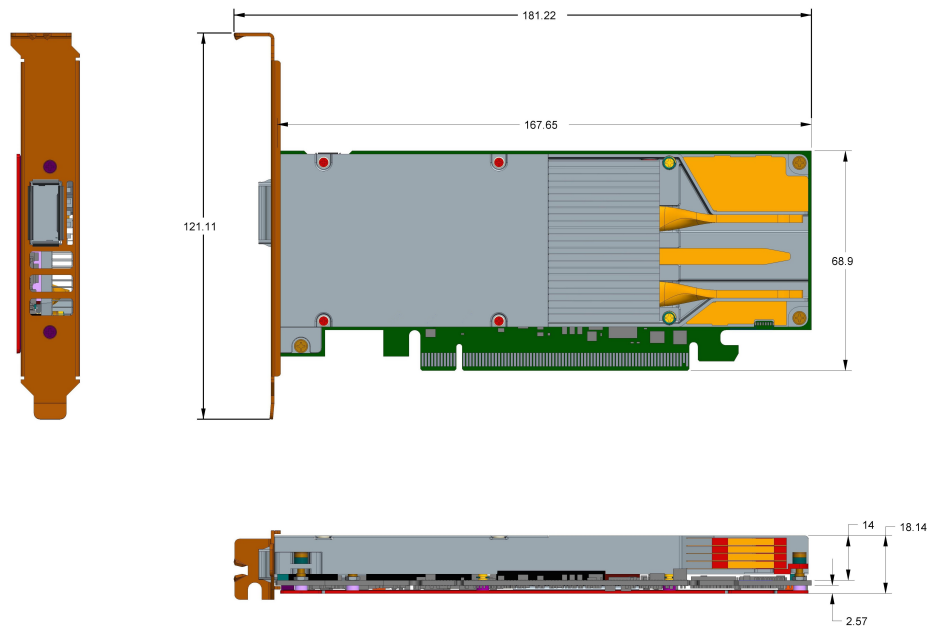


Figure 7. Acceleration Card - Standard Profile Bracket with No Air Duct



You can assemble or disassemble the air duct. Three screws hold the air duct in place. Two screws hold the bracket to the card and heat sink.

Note: Removal of air duct requires a different bracket to be used. Additional bracket options are available in Development Sample only to support the Intel PAC with Intel Arria 10 GX FPGA without air duct.

5. Thermal Specifications

This acceleration card is thermally limited to dissipate no more than 45 W on the FPGA. FPGA junction temperature must not exceed 95°C. Make sure the temperature of the QSFP+ module is within the vendor specification, usually 70°C or 85°C.

- Operating Temperature: 95 °C
- Shutdown Temperature: 100 °C

Refer to the Power Estimator Guide to avoid exceeding 95 °C. Contact your Intel sales representative to get the *Power Estimation and Verification for Intel PAC with Arria 10 GX FPGA* document. This document describes how to verify and ensure that the AFU operates within the power supported by the Intel PAC with Intel Arria 10 GX FPGA.

AFU Developers should use the [Arria 10 PowerPlay Early Power Estimator](#) and the Intel Quartus® Prime Power Analyzer to estimate power consumption.

Figure 8. Airflow Pattern



Related Information

[Power Analysis and Optimization User Guide: Intel Quartus Prime Pro Edition](#)

The Intel Quartus Prime Pro Edition software provides a complete design environment for FPGA and SoC designs. The Power Analyzer is described in the [Power Analysis and Optimization User Guide: Intel Quartus Prime Pro Edition](#).

5.1. Thermal Test Performance Results

Table 8. Terms and Descriptions

| Term | Description |
|------------------------------|---|
| Linear Feet per Minute (LFM) | Air velocity is calculated by dividing the volumetric flow rate by the cross-sectional area of the flow passage. |
| T_{LA} | The measured ambient temperature locally surrounding the FPGA. The ambient temperature should be measured just upstream of a passive heatsink or at fan inlet for an active heatsink. |



Table 9. T_{LA} vs. Velocity Profile with Air Duct

| T_{LA} (°C) | Velocity (LFM) (85 °C QSFP spec) | Velocity (LFM) (70 °C QSFP spec) |
|---------------|----------------------------------|----------------------------------|
| 30 | 270 | 270 |
| 35 | 300 | 300 |
| 40 | 360 | 360 |
| 45 | 420 | 420 |
| 50 | 510 | 510 |
| 55 | 660 | 690 |

Table 10. T_{LA} vs. Velocity Profile without Air Duct

| T_{LA} (°C) | Velocity (LFM) (85 °C QSFP spec) | Velocity (LFM) (70 °C QSFP spec) |
|---------------|----------------------------------|----------------------------------|
| 30 | 330 | 330 |
| 35 | 390 | 390 |
| 40 | 420 | 420 |
| 45 | 510 | 510 |
| 50 | 600 | 630 |
| 55 | 810 | 870 |

6. FPGA Interface Manager

The FPGA Interface Manager (FIM) contains the FPGA logic to support the accelerators, including the PCIe IP core, the Core Cache Interface protocol (CCI-P) fabric, the onboard DDR memory interface, and management engine. Specific features of the FIM are listed in the following documents:

- [Intel Acceleration Stack Quick Start Guide for Intel Programmable Acceleration Card with Intel Arria 10 GX FPGA](#)
- [OPAE Intel FPGA Linux Device Driver Architecture Guide](#)

The 1024 Mb flash memory stores the FPGA Interface Manager (FIM) which provides a common user interface for placement of accelerator functions. In addition, the FIM allows dynamic downloading of new accelerator functions and updates to the FIM.

The FIM can read all sensor data from the BMC, using the Intel Acceleration Stack. For example, to read the FPGA temperature, use the following command:

```
sudo fpgainfo temp
```

To read voltage and current data, use the following command:

```
sudo fpgainfo power
```

Refer to the [Intel Acceleration Stack Quick Start Guide for the Intel Programmable Acceleration Card with Intel Arria 10 GX FPGA](#) to learn how to use these features.

6.1. Updating the FIM

The FIM image in flash memory can be updated using the following methods:

- The primary method is for the FIM to be updated over PCIe via the Acceleration Stack program `fpgaflash`. This loads the FIM image into the onboard flash memory. Upon power up, the board loads the image from flash onto the FPGA.
- Directly configure the FPGA via JTAG through the USB port. This use case should only be used if the FIM image gets corrupted or erased.

Note: Please refer to the [Intel Acceleration Stack Quick Start Guide for the Intel Programmable Acceleration Card with Intel Arria 10 GX FPGA](#) for instructions on updating the FIM.

7. Board Management Controller

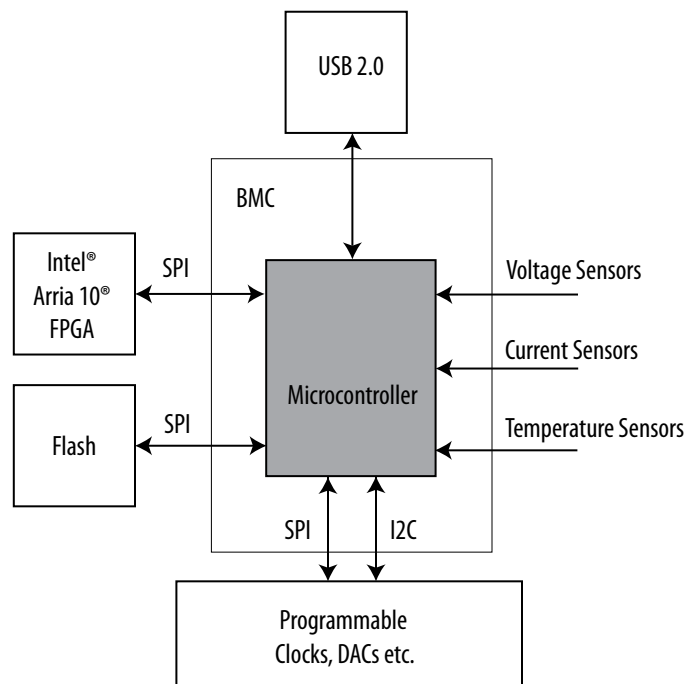
A board management controller (BMC) resides on the Intel PAC with Intel Arria 10 GX FPGA.

7.1. Features

The on-board microcontroller:

- Provides low-level access to board features.
- Interfaces with sensors, FPGA, flash and QSFP.
- Controls power and resets on the board.
- Monitors temperatures, voltages and currents and provides protective action when readings are outside of critical thresholds.
- Provides Platform Level Data Model (PLDM) for PCIe I²C communication. The I²C slave address is 0xC_E.
- Supports field upgrades of BMC firmware.

Figure 9. Board Management Controller for the Intel PAC with Intel Arria 10 GX FPGA



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7.1.1. BMC Voltage and Thermal Handling

The BMC powers down the Intel PAC with Intel Arria 10 GX FPGA and reboots the server if the power, temperature or voltage reaches a certain threshold. This response prevents damage to the server or Intel PAC with Intel Arria 10 GX FPGA.

For threshold limits refer to the *Device Peripheral Table* section. This table shows the upper non-recoverable (UNR) value, which specifies the shutdown condition. The BMC will shut down power to the board under conditions that include the following:

- Backplane voltage reaches 14 V, or current reaches 6A (i.e., a maximum of 84W total power)
- FPGA junction temperature reaches 100°C

Note: The backplane power limits shown above are sufficient to protect the Intel PAC with Intel Arria 10 GX FPGA hardware. If your server components require more conservative limits, you can change any threshold using PLDM commands as described in *PLDM Commands for the Board Management Controller*.

To avoid unintended shutdown and loss of data:

- Use an Intel-validated server.
- Perform extensive power validation and consumption analysis on worst-case workloads.
- Use a qualified solution that is stress-tested across multiple servers and long durations.
- Enable the pacd daemon. This system service monitors sensor readings versus defined thresholds, and disables access to the Intel PAC when it exceeds a threshold. For information about pacd, refer to *OPAE FPGA Tools* in the [Open Programmable Acceleration Engine](#) page.

You can identify whether the BMC has detected a board failure from the two on-board LEDs. Looking into the bracket of the Intel PAC through the venting holes on the back side of the server, you can see four steadily ON green LEDs. Behind them (further into the board), there is either a green LED or red LED that is on. The green LED blinks whenever the BMC is operating and is steadily on if the BMC is being initialized. When the BMC detects a failure condition and holds off board power, a red LED (next to the green LED) will be steadily on. Board failure conditions may occur because of an overheated FPGA or too much power draw from the board.

Related Information

- [PLDM Commands for the Board Management Controller](#) on page 27
- [Device Peripheral Table](#) on page 24

7.2. BMC Tools

The BittWare Toolkit features several utilities that allow you to configure your device in the system, interact with FPGA and debug the FPGA, control the BMC on your board, and access the board from a remote system.

To use the BWConfig and BwMonitor tools, you need a Micro-USB cable to connect the acceleration card to any USB port on host server.



Before using BwMonitor to get telemetry data from the acceleration card, you need to run BwConfig, scan the USB bus, find the card being tested, and map it as device 0.

Note: The OPAE tools `fpgaifnfo` and `fpgaflash` can retrieve BMC telemetry data and update BMC over PCIe, eliminating the need for a USB cable. Refer to the [Intel Acceleration Stack Quick Start Guide for the Intel Programmable Acceleration Card with Intel Arria 10 GX FPGA](#) to learn how to use these features.

7.2.1. BwConfig

BwConfig is a utility for configuring the BMC in a system. BwConfig:

- Controls BMC hardware on the platform
- Scans and maps new devices through PCIe or USB
- Views device properties
- Controls FPGA boot and flash loading
- Can backup flash to restore a factory default image over PCIe
- Supports resetting and loading FPGA images without the need to attach additional cables or hardware

7.2.2. BwMonitor

BwMonitor provides a view into the board management capabilities of your Intel Programmable Acceleration Card with Intel Arria 10 GX FPGA. You can use BwMonitor through a GUI or console. BwMonitor allows you to:

- View board health
- Read and log sensors
- Control sensor thresholds that determine when the board will shut down
- Load programmable clocks
- Override voltages
- Access devices via I²C
- Upgrade the BMC firmware
- Monitor the board over PCIe or USB

7.2.2.1. `bwmonitor --read` Command

Use the `--read` command in the console to read any combination or number of the available peripheral devices. The following table describes the additional arguments that can be used with the `--read` command.

**Table 11. bwmonitor --read Command Argument Options**

| Available Arguments | Description |
|---------------------|--|
| --type | Narrows results to a certain type of peripheral device, for example sensors. |
| --id | Use in conjunction with the --type argument to read only one device. |
| --loop | Continues reading sensors in a loop. |
| --read_every | Controls how often the sensors are read. |

Note: In bwmonitor output, "SDR" is equivalent to PDR (platform descriptor record).

7.2.2.1.1. Example: Read all peripheral devices

```
$ bwmonitor --dev=0 --read
Fri Nov  2 10:35:45 2018
Board Management Controller      A10SA4 dev 0
(1) Microcontroller             Version 26879
SDR Sensors                     A10SA4 dev 0
(0) Board Power                 OK                19 Watts
(1) 12v Backplane Current       OK                1.58 Amps
(2) 12v Backplane Voltage       OK                12.01 Volts
(4) 1.2v Current                OK                2.66 Amps
(3) 1.2v Voltage                OK                1.22 Volts
(6) 1.8v Current                OK                2.54 Amps
(5) 1.8v Voltage                OK                1.84 Volts
(8) 3.3v Current                OK                0.54 Amps
(7) 3.3v Voltage                OK                3.33 Volts
(9) FPGA Core Voltage           OK                0.90 Volts
(10) FPGA Core Current          OK                4.74 Amps
(11) FPGA Core Temperature      OK                39 degrees C
(15) Core Supply Temperature    OK                46 degrees C
(12) Board Temperature          OK                26 degrees C
(14) QSPF Temperature           Unavailable
(13) QSPF Voltage               Unavailable
(17) VCCR Voltage               OK                1.04 Volts
(18) VCCT Voltage               OK                1.04 Volts
(19) VCCR Current               OK                0.90 Amps
(20) VCCT Current               OK                0.43 Amps
(21) VPP Voltage                OK                2.56 Volts
(22) VTT Voltage                OK                0.60 Volts
Pluggable Transceivers (SFP)    A10SA4 dev 0
(0) QSPF
Programmable Clocks (PLL)      A10SA4 dev 0
(0) Si5338                      322.2656, 100, 266.6666, 266.6666
FRU EEPROMs                    A10SA4 dev 0
(0) FRU
FPGAs                           A10SA4 dev 0
(0) FPGA
Networking Modules             A10SA4 dev 0
MAC Prom
1670:0204:5410:0060:c4ae:a000:a000:0065
```

7.2.2.1.2. Example: Read all sensors

```
$ bwmonitor --dev=0 --read --type=sensor
Fri Nov  2 10:37:50 2018
SDR Sensors                     A10SA4 dev 0
(0) Board Power                 OK                19 Watts
(1) 12v Backplane Current       OK                1.58 Amps
(2) 12v Backplane Voltage       OK                12.01 Volts
(4) 1.2v Current                OK                2.66 Amps
(3) 1.2v Voltage                OK                1.22 Volts
(6) 1.8v Current                OK                2.54 Amps
```



| | | | |
|------|-------------------------|-------------|--------------|
| (5) | 1.8v Voltage | OK | 1.84 Volts |
| (8) | 3.3v Current | OK | 0.54 Amps |
| (7) | 3.3v Voltage | OK | 3.33 Volts |
| (9) | FPGA Core Voltage | OK | 0.90 Volts |
| (10) | FPGA Core Current | OK | 4.74 Amps |
| (11) | FPGA Core Temperature | OK | 39 degrees C |
| (15) | Core Supply Temperature | OK | 46 degrees C |
| (12) | Board Temperature | OK | 26 degrees C |
| (14) | QSFP Temperature | Unavailable | |
| (13) | QSFP Voltage | Unavailable | |
| (17) | VCCR Voltage | OK | 1.04 Volts |
| (18) | VCCT Voltage | OK | 1.04 Volts |
| (19) | VCCR Current | OK | 0.90 Amps |
| (20) | VCCT Current | OK | 0.43 Amps |
| (21) | VPP Voltage | OK | 2.56 Volts |
| (22) | VTT Voltage | OK | 0.60 Volts |

7.2.2.1.3. Example: Read the FPGA Core Temperature Sensor

```
$ bwmonitor --dev=0 --read=11 --type=sensor
Fri Nov  2 10:38:59 2018
SDR Sensors           A10SA4 dev 0
(11) FPGA Core Temperature  OK           39 degrees C
```

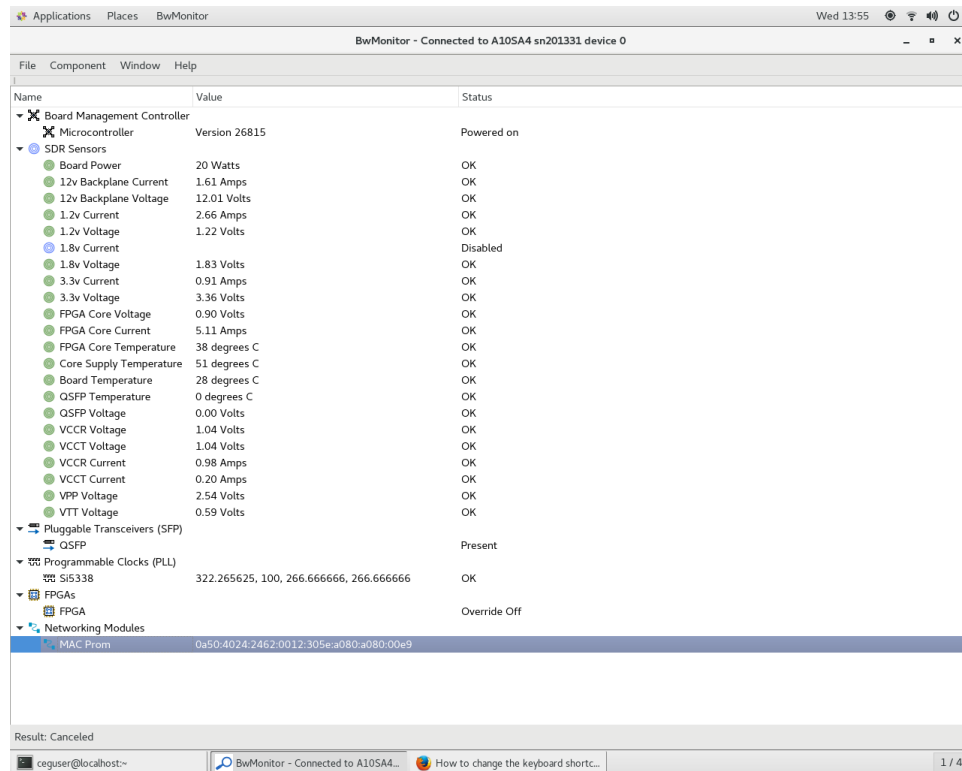


7.2.2.2. How to Invoke the BMC GUI

1. Type the following command:

```
bwmonitor -gui &
```

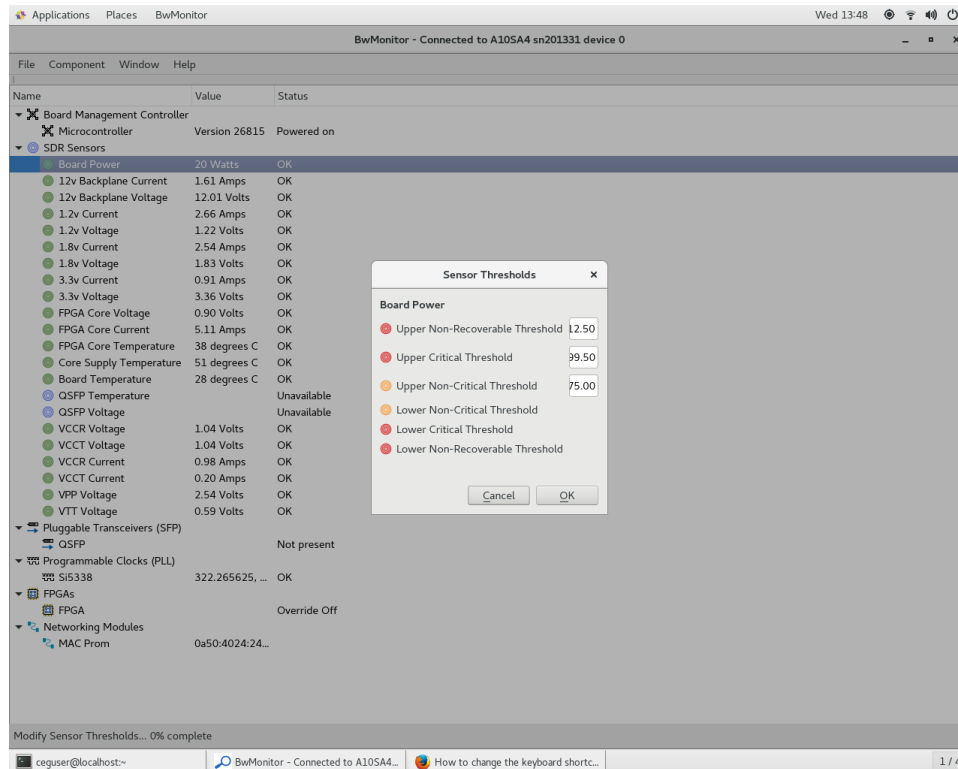
2. Click **connect**



7.2.2.3. BMC Settings

Right-click any sensor with a green icon to open the **Sensor Thresholds** dialog box.

Figure 10. Board Power Sensor Threshold Window



7.2.2.4. Device Peripheral Table

The following table describes the peripherals, currents or voltages that you can monitor on the Intel PAC with Intel Arria 10 GX FPGA:

- Type: Indicates the origin of measurement
- Channel and Address columns: Indicate the virtual I²C channel and address that are used to access the peripheral through the microcontroller.
- ID (DEV/PDR): Indicates the platform descriptor record (PDR) index; otherwise, indicates the device number (DEV), if any, to be passed to the relevant PLDM command.
- UNC: Upper non-critical value
- UC: Upper critical value
- UNR: Upper non-recoverable value: the threshold for power shutdown⁽¹⁾

⁽¹⁾ For a detailed discussion of UNR, refer to *BMC Voltage and Thermal Handling*

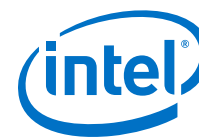


Table 12. Device Peripheral Table

| Name | Type | Channel | Address | ID (DEV/PDR) | UNC | UC | UNR | Description |
|-------------------------|--------------------|---------|---------|--------------|------|-----|------|--|
| Board Power | Sensor | - | - | 0 | 75 | 100 | 113 | - |
| 12v Backplane Current | Sensor | 5 | 0xD4 | 1 | 5.5 | 6 | 6 | LTC4151 Input Current |
| 12v Backplane Voltage | Sensor | 5 | 0xD4 | 2 | 13.5 | 14 | 14 | LTC4151 Input Voltage |
| 1.2v Current | Sensor | 6 | 0xD0 | 4 | 12 | 13 | 15 | LTC4151 Output Current |
| 1.2v Voltage | Sensor | 6 | 0xD0 | 3 | 1.26 | 1.3 | 1.4 | LTC4151 Output Voltage |
| 1.8v Current | Sensor | 6 | 0xD2 | 6 | 6 | 7 | 8 | LTC4151 Output Current |
| 1.8v Voltage | Sensor | 6 | 0xD2 | 5 | 1.9 | 2 | 2.04 | LTC4151 Output Voltage |
| 3.3v Current | Sensor | 6 | 0xD4 | 8 | 6 | 7 | 8 | LTC4151 Output Current |
| 3.3v Voltage | Sensor | 6 | 0xD4 | 7 | 3.47 | 3.6 | 3.96 | LTC4151 Output Voltage |
| FPGA Core Voltage | Sensor | 6 | 0xDA | 9 | 0.95 | 1 | 1.08 | LTC4151 Output Voltage |
| FPGA Core Current | Sensor | 6 | 0xDA | 10 | 50 | 55 | 60 | LTC4151 Output Current |
| FPGA Core Temperature | Sensor | 0 | 0x98 | 11 | 90 | 95 | 100 | NCT72CMTR2G External |
| Core Supply Temperature | Sensor | - | - | 15 | 100 | 110 | 120 | - |
| Board Temperature | Sensor | 0 | 0x98 | 12 | 70 | 75 | 80 | NCT72CMTR2G Local |
| QSFP Temperature | Sensor | 3 | 0xA0 | 14 | 70 | 80 | 90 | - |
| QSFP Voltage | Sensor | 3 | 0xA0 | 13 | 3.4 | 3.5 | 3.7 | - |
| VCCR Voltage | Sensor | - | - | 17 | - | - | - | - |
| VCCT Voltage | Sensor | - | - | 18 | - | - | - | - |
| VCCR Current | Sensor | - | - | 19 | - | - | - | - |
| VCCT Current | Sensor | - | - | 20 | - | - | - | - |
| VPP Voltage | Sensor | - | - | 21 | - | - | - | - |
| VTT Voltage | Sensor | - | - | 22 | - | - | - | - |
| QSFP | SFP/QSFP | - | 0xA0 | 1 | - | - | - | - |
| Si5338 | Programmable Clock | 0 | 0xE0 | 0 | - | - | - | Defaults to 125, 125, 266.666667, 266.666667 |
| MAC Prom | Network | 4 | 0xA0 | - | - | - | - | AT24CS04 |



Note: The table above lists **ID (DEV/PDR)** (device IDs) based at 0, as shown by the Bittware tools and the `fpgainfo` command. However, the PLDM commands use device IDs based at 1. Therefore, when using PLDM commands, you must add 1 to the table device ID to obtain the PLDM device ID. For example, the board power ID is listed as 0 in the *Device Peripheral Table*, but in PLDM commands the board power ID is 1.

Refer to the [Intel Acceleration Stack Quick Start Guide for the Intel Programmable Acceleration Card with Intel Arria 10 GX FPGA](#) for information about the `fpgainfo` command.

Related Information

- [PLDM Commands for the Board Management Controller](#) on page 27
- [BMC Voltage and Thermal Handling](#) on page 19

7.3. Updating the BMC Configuration and Firmware

The BMC contains an in-system programmable boot loader for upgrading the firmware over PCIe or USB. Intel provides the firmware for image upgrades. The upgrade process takes seconds and the board is reset when the upgrade is complete. For directions on how to update the BMC configuration and firmware, you must refer to the *Updating FPGA Flash and BMC Firmware* section in the *Intel Acceleration Stack Quick Start Guide for Intel Programmable Acceleration Card with Intel Arria 10 GX FPGA*.

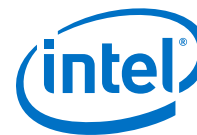
With the Intel Acceleration Stack version 1.2, you can avoid connecting a USB cable by updating BMC firmware over PCIe, using the `fpgaflash` command.

Note: Firmware update over PCIe is supported only by the BMC firmware included with the Intel Acceleration Stack version 1.2 or later. If your board is running an earlier firmware version, you must use a USB cable to upgrade to version 1.2 or later before you can take advantage of the PCIe update feature.

Note: Before updating firmware, verify that your OEM has fully validated the new firmware against your OEM server software version. Intel does not validate BMC firmware against all OEM software versions.

Related Information

[Intel Acceleration Quick Start Guide for Intel Programmable Acceleration Card with Intel Arria 10 GX FPGA](#)



8. PLDM Commands for the Board Management Controller

The BMC on the Intel PAC with Intel Arria 10 GX FPGA can communicate with a server BMC over the PCIe I²C bus. The supported protocol is the PLDM over Management Component Transport Protocol (MCTP) stack.

The PAC BMC supports a subset of PLDM and MCTP commands, to enable a server BMC to obtain sensor data for fan control. The BMC supports version 1.1.1 of the PLDM for Platform Monitoring and Control standard (DMTF specification DSP0248). It does not support version 1.1.0.

For more information about the PLDM and MCTP protocol specifications, refer to *DMTF Specifications* on the [Platform Management Components Intercommunication](#) website.

Note: The PAC BMC does not break large MCTP packets down to 64-byte packets, as described in the MCTP specification for baseline transmission unit size. Otherwise the BMC is fully compliant to the DMTF specifications.

Related Information

[Platform Management Components Intercommunication](#)

8.1. I²C/SMBus Address

The PCIe I²C slave address of the Intel PAC with Intel Arria 10 GX FPGA is fixed at 0xCE. There is no Address Resolution Protocol (ARP) support.

8.2. Supported SMBus Commands

- `smbus_get_udid`

8.3. Supported MCTP Commands

8.3.1. MCTP Control Messages

- `mctp_set_endpoint_id`
- `mctp_get_endpoint_id`
- `mctp_get_endpoint_uuid`
- `mctp_get_mctp_version_support`
- `mctp_get_message_type_support`
- `mctp_get_vendor_defined_message_support`



8.4. Supported PLDM Commands

8.4.1. PLDM Base Specification Commands

- pldm_settid
- pldm_gettid
- pldm_getterminusuid
- pldm_getpldmversion
- pldm_getpldmtypes
- pldm_etpldmcommands

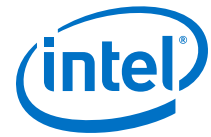
8.4.2. PLDM for Platform Monitoring and Control Specification Commands

- pldm_settid
- pldm_gettid
- pldm_setnumericsensorenable
- pldm_getsensorreading
- pldm_getsensorthresholds
- pldm_setsensorthresholds
- pldm_restoresensorthresholds
- pldm_getsensorhysteresis
- pldm_setsensorhysteresis
- pldm_getpdrrepositoryinfo
- pldm_getpdr

8.5. Defined Platform Descriptor Records

71 Platform Descriptor Records (PDRs) for A10SA4 rev 26815

- NumericSensorPDR_1
- NumericSensorPDR_2
- NumericSensorPDR_3
- NumericSensorPDR_4
- NumericSensorPDR_5
- NumericSensorPDR_6
- NumericSensorPDR_7
- NumericSensorPDR_8
- NumericSensorPDR_9
- NumericSensorPDR_10
- NumericSensorPDR_11
- NumericSensorPDR_12
- NumericSensorPDR_13



- NumericSensorPDR_14
- NumericSensorPDR_15
- NumericSensorPDR_16
- NumericSensorPDR_17
- NumericSensorPDR_18
- NumericSensorPDR_19
- NumericSensorPDR_20
- NumericSensorPDR_21
- NumericSensorPDR_22
- NumericSensorPDR_23
- NumericSensorInitializationPDR_1
- NumericSensorInitializationPDR_2
- NumericSensorInitializationPDR_3
- NumericSensorInitializationPDR_4
- NumericSensorInitializationPDR_5
- NumericSensorInitializationPDR_6
- NumericSensorInitializationPDR_7
- NumericSensorInitializationPDR_8
- NumericSensorInitializationPDR_9
- NumericSensorInitializationPDR_10
- NumericSensorInitializationPDR_11
- NumericSensorInitializationPDR_12
- NumericSensorInitializationPDR_13
- NumericSensorInitializationPDR_14
- NumericSensorInitializationPDR_15
- NumericSensorInitializationPDR_16
- NumericSensorInitializationPDR_17
- NumericSensorInitializationPDR_18
- NumericSensorInitializationPDR_19
- NumericSensorInitializationPDR_20
- NumericSensorInitializationPDR_21
- NumericSensorInitializationPDR_22
- NumericSensorInitializationPDR_23
- SensorAuxiliaryNamesPDR_1
- SensorAuxiliaryNamesPDR_2
- SensorAuxiliaryNamesPDR_3
- SensorAuxiliaryNamesPDR_4
- SensorAuxiliaryNamesPDR_5



- SensorAuxiliaryNamesPDR_6
- SensorAuxiliaryNamesPDR_7
- SensorAuxiliaryNamesPDR_8
- SensorAuxiliaryNamesPDR_9
- SensorAuxiliaryNamesPDR_10
- SensorAuxiliaryNamesPDR_11
- SensorAuxiliaryNamesPDR_12
- SensorAuxiliaryNamesPDR_13
- SensorAuxiliaryNamesPDR_14
- SensorAuxiliaryNamesPDR_15
- SensorAuxiliaryNamesPDR_16
- SensorAuxiliaryNamesPDR_17
- SensorAuxiliaryNamesPDR_18
- SensorAuxiliaryNamesPDR_19
- SensorAuxiliaryNamesPDR_20
- SensorAuxiliaryNamesPDR_21
- SensorAuxiliaryNamesPDR_22
- SensorAuxiliaryNamesPDR_23
- TerminusLocatorPDR
- FRURecordSetPDR_0

8.6. Sensor and Threshold Information

Refer to *Device Peripheral Table* for a list of the peripherals, currents and voltages that can be monitored through the BMC.

Note: Although the PLDM commands use device IDs based at 1, the *Device Peripheral Table* lists device IDs based at 0⁽²⁾ in the **ID (DEV/PDR)** column. Therefore, when referring to a device ID in the table, you must add 1 to obtain the device ID used by the PLDM commands. For example, the board power ID is listed as 0 in the *Device Peripheral Table*, while PLDM commands use 1.

Related Information

[Device Peripheral Table](#) on page 24

⁽²⁾ as shown by the Bittware tools and the `fpgainfo` command



A. Regulatory Information

Regulatory Model Number: 10AX115

United States Federal Communications Commission (FCC) Class A User Information

The Class A Product: Intel Programmable Acceleration Card with Intel Arria 10 GX FPGA complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions:

1. This device may not cause harmful interference.
2. This device must accept the interference received, including interference that may cause undesired operation.

Attention: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to Part 15 of the FCC rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with other instructions, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference is at his/her own expense.

Caution: If this device is changed or modified without permission from Intel, the user may void his or her authority to operate the equipment.

VCCI Class A Statement

この装置は、クラスA情報技術装置です。この装置を家庭環境で使用すると電波妨害を引き起こすことがあります。この場合には使用者が適切な対策を講ずるよう要求されることがあります。

VCCI-A

BSMI Class A Statement

警告使用者:

此為甲類資訊技術設備，於居住環境中使用時，可能會造成射頻擾動，在此種情況下，使用者會被要求採取某些適當的對策。

Republic of Korea KCC Notice Class A

| | |
|--|--|
| <p>A급 기기 (업무용 방송통신기기)</p> <p>CLASS A device (commercial broadcasting and communication equipment)</p> | <p>이 기기는 업무용(A급)으로 전자파적합등록을 한 기기이오니 판매자 또는 사용자는 이 점을 주의하시기 바라며, 가정외의 지역에서 사용하는 것을 목적으로 합니다.</p> <p>This device has been approved by EMC registration. Distributors or users pay attention to this point. This device is usually aimed to be used in other area except at home.</p> |
|--|--|

Canada EMC Compliance Statement

This Class A digital apparatus complies with Canadian ICES-003.

Cet appareil numérique de la classe A est conforme à la norme NMB-003 du Canada.

European Community Manufacturer Declaration



Belgium

Par la présente, Intel Corporation déclare que la carte Intel PAC with Intel Arria 10 GX FPGA est conforme aux directives 2014/30/UE, 2014/35/UE et 2011/65/UE.

Att. Corp Quality, Intel Deutschland GmbH, Am Campeon 10-12, Neubiberg, 85579 - Germany

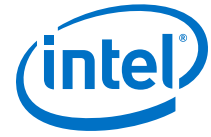
Le texte intégral en anglais de la déclaration européenne de conformité est disponible à l'adresse suivante: [Declaration of Conformity](#)

Denmark

Intel Corporation erklærer hermed, at Intel PAC with Intel Arria 10 GX FPGA overholder direktiverne 2014/30/EU, 2014/35/EU og 2011/65/EU.

Att. Corp Quality, Intel Deutschland GmbH, Am Campeon 10-12, Neubiberg, 85579 - Germany

Den fulde tekst for EUs overensstemmelseserklæring findes på engelsk på følgende adresse: [Declaration of Conformity](#)



Netherlands

Intel Corporation verklaart hierbij dat Intel PAC with Intel Arria 10 GX FPGA in overeenstemming is met de richtlijnen 2014/30/EU, 2014/35/EU en 2011/65/EU.

Att. Corp Quality, Intel Deutschland GmbH, Am Campeon 10-12, Neubiberg, 85579 - Germany

De volledige Engelse tekst van de EU-conformiteitsverklaring is hier beschikbaar: [Declaration of Conformity](#)

Germany

Hiermit erklärt die Intel Corporation, dass die Intel PAC with Intel Arria 10 GX FPGA den Richtlinien 2014/30/EU, 2014/35/EU und 2011/65/EU entspricht.

Att. Corp Quality, Intel Deutschland GmbH, Am Campeon 10-12, Neubiberg, 85579 - Germany

Die vollständige EU-Konformitätserklärung ist in englischer Sprache unter der folgenden URL einsehbar: [Declaration of Conformity](#)

Sweden

Härmed intygar Intel Corporation att Intel PAC with Intel Arria 10 GX FPGA överensstämmer med direktiven 2014/30/EU, 2014/35/EU och 2011/65/EU.

Att. Corp Quality, Intel Deutschland GmbH, Am Campeon 10-12, Neubiberg, 85579 - Germany

Den fullständiga engelska texten för EU-överensstämmelsen finns på följande internetadress: [Declaration of Conformity](#)

Finland

Intel Corporation vakuuttaa täten, että Intel PAC with Intel Arria 10 GX FPGA on direktiivien 2014/30/EU, 2014/35/EU ja 2011/65/EU määräysten mukainen.

Att. Corp Quality, Intel Deutschland GmbH, Am Campeon 10-12, Neubiberg, 85579 - Germany

EU-vaatimustenmukaisuusvakuutuksen koko englanninkielinen teksti on saatavilla osoitteessa: [Declaration of Conformity](#)

Ireland

Hereby, Intel Corporation declares that the Intel PAC with Intel Arria 10 GX FPGA is in compliance with Directives 2014/30/EU, 2014/35/EU and 2011/65/EU.

Att. Corp Quality, Intel Deutschland GmbH, Am Campeon 10-12, Neubiberg, 85579 - Germany

The full text of the EU declaration of conformity is available at the following URL: [Declaration of Conformity](#)



Portugal

A Intel Corporation declara, por este meio, que a Intel PAC with Intel Arria 10 GX FPGA cumpre as Diretivas 2014/30/UE, 2014/35/UE e 2011/65/UE.

Att. Corp Quality, Intel Deutschland GmbH, Am Campeon 10-12, Neubiberg, 85579 - Germany

Pode consultar o texto da declaração de conformidade da UE na íntegra, disponível em inglês através do seguinte URL: [Declaration of Conformity](#)

Spain

Por la presente, Intel Corporation declara que Intel PAC with Intel Arria 10 GX FPGA cumple las directivas 2014/30/UE, 2014/35/UE y 2011/65/UE.

Att. Corp Quality, Intel Deutschland GmbH, Am Campeon 10-12, Neubiberg, 85579 - Germany

El texto completo (en inglés) de la declaración de conformidad de la UE está disponible en la siguiente URL: [Declaration of Conformity](#)

France

Par la présente, Intel Corporation déclare que la carte Intel PAC with Intel Arria 10 GX FPGA est conforme aux directives 2014/30/UE, 2014/35/UE et 2011/65/UE.

Att. Corp Quality, Intel Deutschland GmbH, Am Campeon 10-12, Neubiberg, 85579 - Germany

Le texte intégral en anglais de la déclaration européenne de conformité est disponible à l'adresse suivante: [Declaration of Conformity](#)

Italy

Con il presente documento, Intel Corporation dichiara che la scheda di accelerazione programmabile Intel PAC with Intel Arria 10 GX FPGA è conforme alle direttive 2014/30/EU, 2014/35/EU e 2011/65/EU.

Att. Corp Quality, Intel Deutschland GmbH, Am Campeon 10-12, Neubiberg, 85579 - Germany

Il testo completo della dichiarazione di conformità UE in lingua inglese è disponibile al seguente indirizzo: [Declaration of Conformity](#)

United Kingdom

Hereby, Intel Corporation declares that the Intel PAC with Intel Arria 10 GX FPGA is in compliance with Directives 2014/30/EU, 2014/35/EU and 2011/65/EU.

Att. Corp Quality, Intel Deutschland GmbH, Am Campeon 10-12, Neubiberg, 85579 - Germany

The full text of the EU declaration of conformity is available at the following URL: [Declaration of Conformity](#)



Poland

Firma Intel Corporation niniejszym oświadcza, że karta Intel PAC with Intel Arria 10 GX FPGA jest zgodna z dyrektywami 2014/30/UE, 2014/35/UE i 2011/65/UE.

Att. Corp Quality, Intel Deutschland GmbH, Am Campeon 10-12, Neubiberg, 85579 - Germany

Pełny tekst deklaracji zgodności z wymogami UE w języku angielskim jest dostępny na stronie: [Declaration of Conformity](#)

End-of-Life/ Product Recycling

Product recycling and end-of-life take-back systems and requirements vary by country.


Contact the retailer or distributor of this product for information about product recycling and/or take-back.

Regulatory Markings

| | | | |
|-------------------------|--|-----------------------|--|
| | | | |
| | | R-REM-CPU-10AX115 | |
| CAN ICES-3 (A)/NMB-3(A) | | | |

Hazardous Substances Table

产品中有毒有害物质的名称及含量

| 部件名称 Component Name | 有毒有害物质或元素 Hazardous Substance | | | | | |
|--|-------------------------------|---------|---------|----------------|-------------|---------------|
| | 铅 Pb | 汞 Hg | 镉 Cd | 六价铬 Cr (VI) | 多溴联苯 PBB | 多溴二苯醚 PBDE |
| 金属部件 Metal Parts | ○ | ○ | ○ | ○ | ○ | ○ |
| 印刷电路板组件 Printed Board Assemblies (PBA) | X | ○ | ○ | ○ | ○ | ○ |
| <p>○：表示该有毒有害物质在该部件所有均质材料中的含量均在GB/T 26572标准规定的限量要求以下。 ○: Indicates that this hazardous substance contained in all homogeneous materials of such component is within the limits specified in GB/T 26572.</p> <p>×：表示该有毒有害物质至少在该部件的某一均质材料中的含量超出GB/T 26572标准规定的限量要求。 ×: Indicates that the content of such hazardous substance in at least a homogeneous material of such component exceeds the limits specified in GB/T 26572.</p> <p>对销售之日的所售产品, 本表显示我公司供应链的电子信息产品可能包含这些物质。注意: 在所售产品中可能会也可能不会含有所有所列的部件。 This table shows where these substances may be found in the supply chain of our electronic information products, as of the date of sale of the enclosed product. Note that some of the component types listed above may or may not be a part of the enclosed product.</p> <p>除非另外特别的标注, 此标志为针对所涉及产品的环保使用期限标志。某些可更换的零部件可能会有一个不同的环保使用期限(例如, 电池单元模块)。 此环保使用期限只适用于产品在产品手册中所规定的条件下工作。</p> | | | | | | |
|  | | | | | | |
| <p>The Environment-Friendly Use Period (EFUP) for all enclosed products and their parts are per the symbol shown here, unless otherwise marked. Certain field-replaceable parts may have a different EFUP (for example, battery modules) number. The Environment-Friendly Use Period is valid only when the product is operated under the conditions defined in the product manual.</p> | | | | | | |



B. References

Related Information

[Intel Arria 10 GX/GT Device Errata and Design Recommendations](#)

This errata sheet provides information about known device issues affecting Intel Arria 10 GX/GT devices. It also offers design recommendations you should follow when using Intel Arria 10 GX/GT devices.

C. Document Revision History for Intel Programmable Acceleration Card (PAC) with Intel Arria 10 GX FPGA Data Sheet

| Document Version | Changes |
|------------------|--|
| 2019.05.30 | <ul style="list-style-type: none"> Updated <i>Figure: Intel Programmable Acceleration Card with Intel Arria 10 GX FPGA</i>. Updated <i>Appendix: Regulatory Information</i>. |
| 2019.03.26 | Updated Views of the Intel PAC with Intel Arria 10 GX FPGA on page 5. Removed reference to ECC from PAC block diagram. |
| 2018.12.04 | <ul style="list-style-type: none"> Updated for Acceleration Stack version 1.2. Maintains support for Acceleration Stack version 1.1. Updated BMC version with support for PCIe update Added <i>PLDM Commands for the Board Management Controller</i> chapter Updated the following sections: <ul style="list-style-type: none"> <i>FPGA Interface Manager</i> in the <i>FPGA Interface Manager</i> chapter <i>BMC Voltage and Thermal Handling</i> in the <i>Board Management Controller</i> chapter <i>BwMonitor</i> in the <i>Board Management Controller</i> chapter <i>Updating the BMC Configuration and Firmware</i> in the <i>Board Management Controller</i> chapter ECC not supported in on-board memory Clarified: BMC communication based on PLDM for Platform Monitoring and Control Terminology correction: previously SDR, now PDR |
| 2018.08.16 | Corrected broken link in <i>FPGA Interface Manager</i> . |
| 2018.08.06 | Updated the following sections: <ul style="list-style-type: none"> Introduction Block Diagram QSFP+ System Compatibility Interfaces and Dimensions Added substantial content to the <i>Board Management Controller</i> chapter |
| 2018.04.11 | Updated the following sections: <ul style="list-style-type: none"> On-Board Memory on page 6 QSFP+ on page 7 Power on page 7 Board Management Controller on page 18 System Compatibility on page 10 Mechanical Information Thermal Specifications on page 15 |
| 2018.01.22 | Updated the following sections: <ul style="list-style-type: none"> Introduction on page 3 On-Board Memory on page 6 Interfaces and Dimensions on page 6 Power on page 7 CPLD on page 7 Board Management Controller on page 18 |

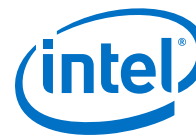
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C. Document Revision History for Intel Programmable Acceleration Card (PAC) with Intel Arria 10 GX FPGA Data Sheet

DS-1054 | 2019.05.30



| Document Version | Changes |
|------------------|--|
| | <ul style="list-style-type: none">• Mechanical Information• Thermal Test Performance Results on page 15• Regulatory Information on page 31 |
| 2017.11.03 | Initial Release |